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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









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HUFA75639G3, HUFA75639P3, HUFA75639S3S

Data Sheet

December 2001

56A, 100V, 0.025 Ohm, N-Channel UltraFET Power MOSFETs



These N-Channel power MOSFETs are manufactured using the innovative UltraFET® process. This advanced process technology

achieves the lowest possible on-resistance per silicon area, resulting in outstanding performance. This device is capable of withstanding high energy in the avalanche mode and the diode exhibits very low reverse recovery time and stored charge. It was designed for use in applications where power efficiency is important, such as switching regulators, switching converters, motor drivers, relay drivers, low-voltage bus switches, and power management in portable and battery-operated products.

Formerly developmental type TA75639.

Ordering Information

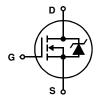
PART NUMBER	PACKAGE	BRAND
HUFA75639G3	TO-247	75639G
HUFA75639P3	TO-220AB	75639P
HUFA75639S3S	TO-263AB	75639S

NOTE: When ordering, use the entire part number. Add the suffix T to obtain the TO-263AB variant in tape and reel, e.g., HUFA75639S3ST.

Features

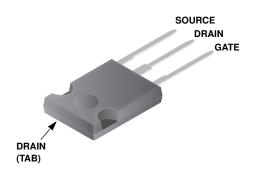
- 56A, 100V
- · Simulation Models
 - Temperature Compensated PSPICE® and SABER™ Electrical Models
 - Spice and Saber Thermal Impedance Models
 - www.fairchildsemi.com
- · Peak Current vs Pulse Width Curve
- · UIS Rating Curve
- · Related Literature
 - TB334, "Guidelines for Soldering Surface Mount Components to PC Boards"

Symbol

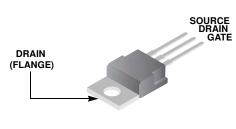


Packaging

JEDEC STYLE TO-247



JEDEC TO-220AB



JEDEC TO-263AB



This product has been designed to meet the extreme test conditions and environment demanded by the automotive industry. For a copy of the requirements, see AEC Q101 at: http://www.aecouncil.com/

Reliability data can be found at: http://www.fairchildsemi.com/products/discrete/reliability/index.html.

HUFA75639G3, HUFA75639P3, HUFA75639S3S

Absolute Maximum Ratings $T_C = 25^{\circ}C$, Unless Otherwise Specified

		UNITS
Drain to Source Voltage (Note 1)	100	V
Drain to Gate Voltage ($R_{GS} = 20k\Omega$) (Note 1)	100	V
Gate to Source Voltage	±20	V
Drain Current		
Continuous (Figure 2)	56	Α
Pulsed Drain Current	Figure 4	
Pulsed Avalanche Rating E _{AS}	Figures 6, 14, 15	
Power Dissipation	200	W
Derate Above 25°C	1.35	W/°C
Operating and Storage Temperature	-55 to 175	°C
Maximum Temperature for Soldering		
Leads at 0.063in (1.6mm) from Case for 10sT _L	300	°C
Package Body for 10s, See Techbrief 334	260	°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

1. $T_J = 25^{\circ}C$ to $150^{\circ}C$.

Electrical Specifications T_C = 25°C, Unless Otherwise Specified

PARAMETER	SYMBOL	TEST	CONDITIONS	MIN	TYP	MAX	UNITS
OFF STATE SPECIFICATIONS	!	*		!			
Drain to Source Breakdown Voltage	BV _{DSS}	$I_D = 250\mu A$, $V_{GS} = 0V$ (Figure 11)		100	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 95V, V _{GS} = 0V		-	-	1	μА
		V _{DS} = 90V, V _{GS} =	$0V, T_C = 150^{\circ}C$	-	-	250	μΑ
Gate to Source Leakage Current	I _{GSS}	V _{GS} = ±20V		-	-	±100	nA
ON STATE SPECIFICATIONS							
Gate to Source Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 25$	50μA (Figure 10)	2	-	4	٧
Drain to Source On Resistance	r _{DS(ON)}	I _D = 56A, V _{GS} = 10	V (Figure 9)	-	0.021	0.025	Ω
THERMAL SPECIFICATIONS					1	-	Ī.
Thermal Resistance Junction to Case	$R_{ heta JC}$	(Figure 3)		-	-	0.74	°C/W
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	R _{θJA} TO-247 TO-220, TO-263		-	-	30	°C/W
				-	-	62	°C/W
SWITCHING SPECIFICATIONS (V _{GS} = 10)V)						
Turn-On Time	ton	$V_{DD} = 50V, I_{D} \cong 56A,$ $R_{L} = 0.89\Omega, V_{GS} = 10V,$ $R_{GS} = 5.1\Omega$		-	-	110	ns
Turn-On Delay Time	t _d (ON)			-	15	-	ns
Rise Time	t _r			-	60	-	ns
Turn-Off Delay Time	t _d (OFF)			-	20	-	ns
Fall Time	t _f			-	25	-	ns
Turn-Off Time	tOFF			-	-	70	ns
GATE CHARGE SPECIFICATIONS							
Total Gate Charge	Q _{g(TOT)}	$V_{GS} = 0V$ to 20V	$V_{DD} = 50V,$ $I_{D} \cong 56A,$ $R_{I} = 0.89\Omega$	-	110	130	nC
Gate Charge at 10V	Q _{g(10)}	V _{GS} = 0V to 10V		-	57	75	nC
Threshold Gate Charge	Q _{g(TH)}	$V_{GS} = 0V \text{ to } 2V$	$I_{g(REF)} = 1.0 \text{mA}$	-	3.7	4.5	nC
Gate to Source Gate Charge	Q _{gs}		(Figure 13)	-	9.8	-	nC
Gate to Drain "Miller" Charge	Q _{gd}			-	24	-	nC

HUFA75639G3, HUFA75639P3, HUFA75639S3S

Electrical Specifications $T_C = 25^{\circ}C$, Unless Otherwise Specified

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
CAPACITANCE SPECIFICATIONS						
Input Capacitance	C _{ISS}	$V_{DS} = 25V, V_{GS} = 0V,$	-	2000	-	pF
Output Capacitance	C _{OSS}	f = 1MHz (Figure 12)	-	500	-	pF
Reverse Transfer Capacitance	C _{RSS}		-	65	-	pF

Source to Drain Diode Specifications

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Source to Drain Diode Voltage	V_{SD}	I _{SD} = 56A	-	-	1.25	V
Reverse Recovery Time	t _{rr}	$I_{SD} = 56A$, $dI_{SD}/dt = 100A/\mu s$	-	-	110	ns
Reverse Recovered Charge	Q _{RR}	$I_{SD} = 56A, dI_{SD}/dt = 100A/\mu s$		-	320	nC

Typical Performance Curves

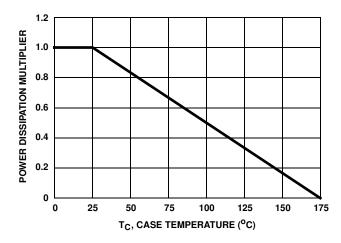


FIGURE 1. NORMALIZED POWER DISSIPATION vs CASE TEMPERATURE

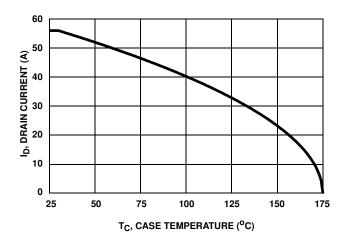


FIGURE 2. MAXIMUM CONTINUOUS DRAIN CURRENT vs CASE TEMPERATURE

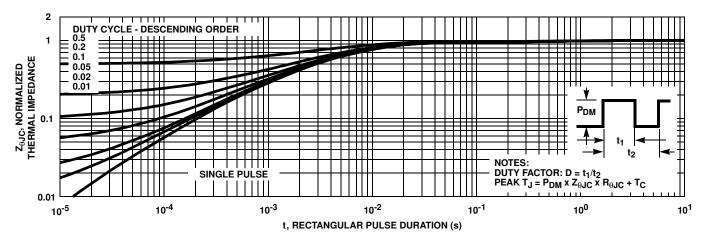


FIGURE 3. NORMALIZED MAXIMUM TRANSIENT THERMAL IMPEDANCE

Typical Performance Curves (Continued)

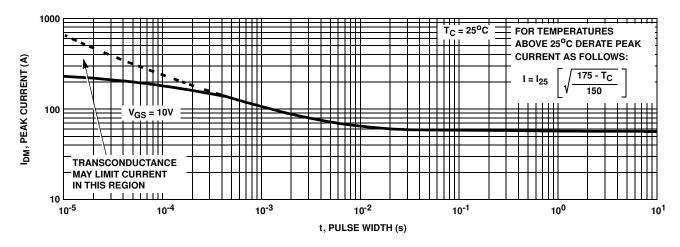


FIGURE 4. PEAK CURRENT CAPABILITY

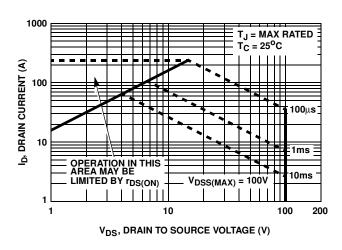


FIGURE 5. FORWARD BIAS SAFE OPERATING AREA

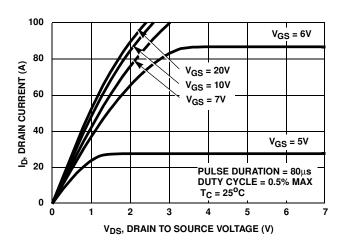
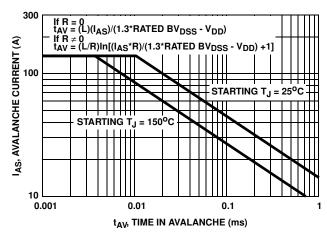


FIGURE 7. SATURATION CHARACTERISTICS



NOTE: Refer to Fairchild Application Notes AN9321 and AN9322. FIGURE 6. UNCLAMPED INDUCTIVE SWITCHING CAPABILITY

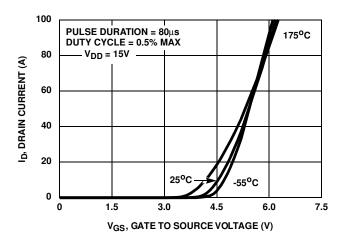


FIGURE 8. TRANSFER CHARACTERISTICS

Typical Performance Curves (Continued)

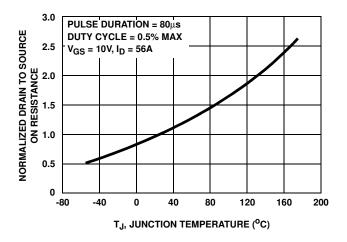


FIGURE 9. NORMALIZED DRAIN TO SOURCE ON RESISTANCE vs JUNCTION TEMPERATURE

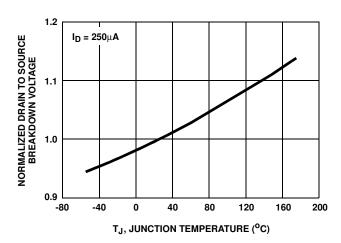


FIGURE 11. NORMALIZED DRAIN TO SOURCE BREAKDOWN VOLTAGE vs JUNCTION TEMPERATURE

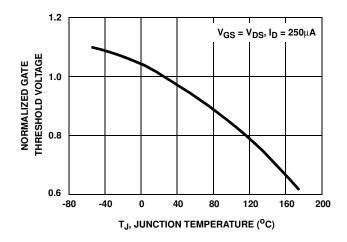


FIGURE 10. NORMALIZED GATE THRESHOLD VOLTAGE vs JUNCTION TEMPERATURE

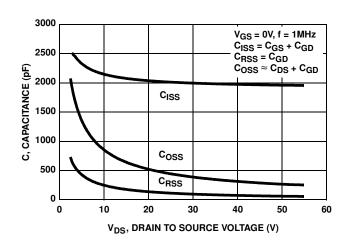
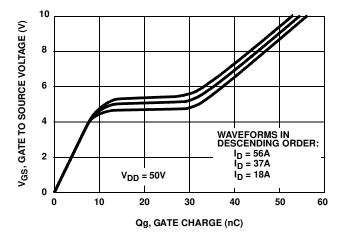


FIGURE 12. CAPACITANCE vs DRAIN TO SOURCE VOLTAGE



NOTE: Refer to Fairchild Application Notes AN7254 and AN7260.

FIGURE 13. GATE CHARGE WAVEFORMS FOR CONSTANT GATE CURRENT

Test Circuits and Waveforms

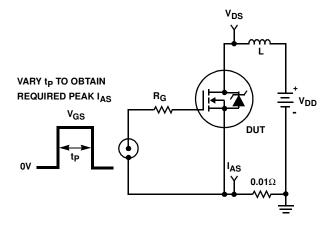


FIGURE 14. UNCLAMPED ENERGY TEST CIRCUIT

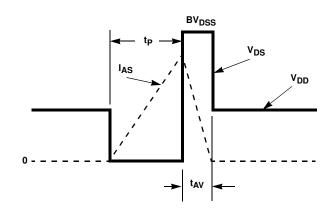


FIGURE 15. UNCLAMPED ENERGY WAVEFORMS

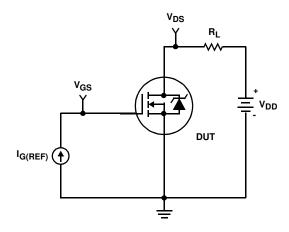


FIGURE 16. GATE CHARGE TEST CIRCUIT

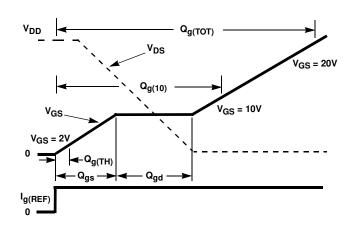


FIGURE 17. GATE CHARGE WAVEFORM

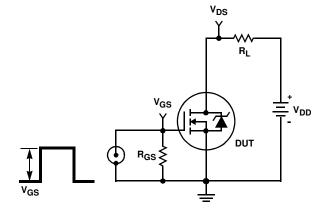


FIGURE 18. SWITCHING TIME TEST CIRCUIT

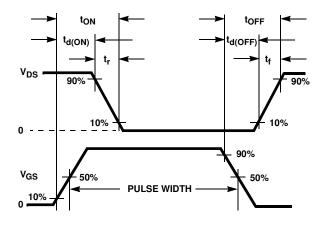


FIGURE 19. RESISTIVE SWITCHING WAVEFORMS

PSPICE Electrical Model

```
SUBCKT HUFA75639 2 1 3 :
                              rev Oct. 98
CA 12 8 2.8e-9
CB 15 14 2.65e-9
CIN 6 8 1.9e-9
                                                                                                            LDRAIN
                                                                 DPLCAP
                                                                                                                      DRAIN
DBODY 7 5 DBODYMOD
DBREAK 5 11 DBREAKMOD
                                                             10
DPLCAP 10 5 DPLCAPMOD
                                                                                                            RLDRAIN
                                                                             RSLC1
                                                                                           DBREAK 
EBREAK 11 7 17 18 110
                                                                             51
                                                               RSLC2
EDS 14 8 5 8 1
EGS 13 8 6 8 1
                                                                               ESLC
                                                                                                  11
ESG 6 10 6 8 1
EVTHRES 6 21 19 8 1
                                                                             50
EVTEMP 20 6 18 22 1
                                                                                                   17
18
                                                                             RDRAIN
                                                                                                         ■ DBODY
                                                            8
                                                                                         EBREAK
                                                      ESG
IT 8 17 1
                                                                 EVTHRES
                                                                                16
                                                                             21
                                                                    19
8
                                                                                            MWEAK
LDRAIN 2 5 2e-9
                                    I GATE
                                                    EVTEMP
LGATE 1 9 1e-9
                                             RGATE
                            GATE
LSOURCE 3 7 0.47e-9
                                                                                   MMED
                                                       22
                                            9
                                                   20
                                                                           MSTRC
BIGATE 1910
                                    RI GATE
RLDRAIN 2 5 20
                                                                                                           LSOURCE
                                                                       CIN
                                                                                                                      SOURCE
RLSOURCE 3 7 4.69
                                                                                 8
                                                                                                                        3
MMED 16 6 8 8 MMEDMOD
                                                                                           RSOURCE
                                                                                                           RLSOURCE
MSTRO 16 6 8 8 MSTROMOD
                                                               o SZA
MWEAK 16 21 8 8 MWEAKMOD
                                                     S1A
                                                                                                RBREAK
                                                   12 ┌
                                                         13
8
                                                                      15
                                                                                           17
                                                                                                         18
RBREAK 17 18 RBREAKMOD 1
                                                               13
RDRAIN 50 16 RDRAINMOD 1.3e-2
                                                     SIR
                                                                S2B
                                                                                                         RVTEMP
RGATE 9 20 0.7
                                                            13
RSLC1 5 51 RSLCMOD 1e-6
                                                                       CB
                                                                                                          19
                                               CA
                                                                                          IT
RSLC2 5 50 1e3
                                                                            14
RSOURCE 8 7 RSOURCEMOD 4.5e-3
                                                                                                           VBAT
RVTHRES 22 8 RVTHRESMOD 1
                                                               8
                                                        EGS
                                                                    EDS
RVTEMP 18 19 RVTEMPMOD 1
                                                                                        8
S1A 6 12 13 8 S1AMOD
                                                                                               RVTHRES
S1B 13 12 13 8 S1BMOD
S2A 6 15 14 13 S2AMOD
S2B 13 15 14 13 S2BMOD
VBAT 22 19 DC 1
ESLC 51 50 VALUE = \{(V(5,51)/ABS(V(5,51)))*(PWR(V(5,51)/(1e-6*115),4))\}
.MODEL DBODYMOD D (IS = 1.4e-12 RS = 3.3e-3 XTI = 4.7 TRS1 = 2e-3 TRS2 = 0.1e-5 CJO = 3.3e-9 TT = 6.1e-8 M = 0.7)
.MODEL DBREAKMOD D (RS = 3.5e- 1TRS1 = 1e- 3TRS2 = 1e-6)
.MODEL DPLCAPMOD D (CJO = 2.2e- 9IS = 1e-3 0N = 10 M = 0.95 vj = 1.0)
.MODEL MMEDMOD NMOS (VTO = 3.5 \text{ KP} = 4.8 \text{ IS} = 1e-30 \text{ N} = 10 \text{ TOX} = 1 \text{ L} = 1 \text{u W} = 1 \text{u Rg} = 0.7)
.MODEL MSTROMOD NMOS (VTO = 3.97 KP = 56.5 IS = 1e-30 N = 10 TOX = 1 L = 1u W = 1u)
MODEL MWEAKMOD NMOS (VTO =3.11 KP = 0.085 IS = 1e-30 N = 10 TOX = 1 L = 1u W = 1u RG = 7 RS = 0.1)
.MODEL RBREAKMOD RES (TC1 = 0.8e- 3TC2 = 1e-6)
.MODEL RDRAINMOD RES (TC1 = 1e-2 TC2 = 1.75e-5)
.MODEL RSLCMOD RES (TC1 = 2.8e-3 TC2 = 14e-6)
MODEL RSOURCEMOD RES (TC1 = 0 TC2 = 0)
.MODEL RVTHRESMOD RES (TC = -2.0e-3 TC2 = -1.75e-5)
.MODEL RVTEMPMOD RES (TC1 = -2.75e- 3TC2 = 0.05e-9)
.MODEL S1AMOD VSWITCH (RON = 1e-5 ROFF = 0.1 VON = -6.0 VOFF = -3.5)
.MODEL S1BMOD VSWITCH (RON = 1e-5 ROFF = 0.1 VON = -3.5 VOFF = -6.0)
.MODEL S2AMOD VSWITCH (RON = 1e-5 ROFF = 0.1 VON = -2.5 VOFF = 4.95)
.MODEL S2AMOD VSWITCH (RON = 1e-5 ROFF = 0.1 VON = 4.95 VOFF = -2.5)
.ENDS
```

NOTE: For further discussion of the PSPICE model, consult **A New PSPICE Sub-Circuit for the Power MOSFET Featuring Global Temperature Options:** IEEE Power Electronics Specialist Conference Records. 1991, written by William J. Hepp and C. Frank Wheatley.

SABER Electrical Model

nom temp=25 deg c 100v Ultrafet

```
REV Oct. 98
template HUFA75639 n2,n1,n3
electrical n2,n1,n3
                                                                                                                            LDRAIN
var i iscl
                                                                             DPLCAP
                                                                                                                                      DRAIN
d..model dbodymod = (is=1.4e-12, xti=4.7, cjo=33e-10,tt=6.1e-8, m=0.7)
                                                                         10
d..model dbreakmod = ()
d..model dplcapmod = (cjo=22e-10,is=1e-30,n=10,m=0.95, vj=1.0)
                                                                                                                           RLDRAIN
                                                                                          RSLC1
m..model mmedmod = (type=\_n,vto=3.5,kp=4.8,is=1e-30, tox=1)
                                                                                                       RDBREAK
                                                                                         51
m..model mstrongmod = (type=_n, vto=3.97, kp=56.5, is=1e-30, tox=1)
                                                                           RSLC2
m..model mweakmod = (type=_n,vto=3.11,kp=0.085,is=1e-30, tox=1)
                                                                                                               72
                                                                                                                           RDBODY
                                                                                            ISCL
sw_vcsp..model s1amod = (ron=1e-5,roff=0.1,von=-6.0,voff=-3.5)
sw_vcsp..model s1bmod = (ron=1e-5,roff=0.1,von=-3.5,voff=-6.0)
                                                                                                        DBREAK
                                                                                          50
sw vcsp..model s2amod = (ron=1e-5,roff=0.1,von=-2.5,voff=4.95)
sw_vcsp..model s2bmod = (ron=1e-5,roff=0.1,von=4.95,voff=-2.5)
                                                                                         > RDRAIN
                                                                       8
                                                                 ESG
                                                                                                                11
c.ca n12 n8 = 28.5e-10
                                                                             EVTHRES
                                                                                             16
c.cb n15 n14 = 26.5e-10
                                                                                         21
                                                                                                          MWEAK
c.cin n6 n8 = 19e-10
                                             LGATE
                                                               EVTEMP
                                                                                                                           DBODY
                                    GATE
                                                       RGATE
                                                                                                          EBREAK
                                                                                                MMED
d.dbody n7 n71 = model=dbodymod
                                                                  22
                                                              20
d.dbreak n72 n11 = model=dbreakmod
                                                                                        MSTRO
                                             RLGATE
d.dplcap n10 n5 = model=dplcapmod
                                                                                                                           LSOURCE
                                                                                   CIN
                                                                                                                                      SOURCE
                                                                                              8
i.it n8 n17 = 1
                                                                                                         RSOURCE
I.ldrain n2 n5 = 2.0e-9
                                                                                                                          RLSOURCE
I.lgate n1 n9 = 1e-9
                                                                S1A
                                                                            S2A
I.Isource n3 n7 = 4.69e-10
                                                                                                              RBREAK
                                                             12
                                                                   13
8
                                                                                   15
                                                                          14
13
m.mmed n16 n6 n8 n8 = model=mmedmod, l=1u, w=1u
m.mstrong n16 n6 n8 n8 = model=mstrongmod, l=1u, w=1u
                                                                S<sub>1</sub>B
                                                                          o SZB
                                                                                                                         RVTEMP
m.mweak n16 n21 n8 n8 = model=mweakmod, l=1u, w=1u
                                                                                   СВ
                                                                                                                         19
                                                         CA
                                                                                                        IT
res.rbreak n17 n18 = 1, tc1=0.8e-3,tc2=-1e-6
res.rdbody n71 n5 = 3.3e-3, tc1=2.0e-3, tc2=0.1e-5
                                                                                                                           VBAT
                                                                   EGS
                                                                                EDS
res.rdbreak n72 n5 = 3.5e-1, tc1=1e-3, tc2=1e-6
res.rdrain n50 n16 = 13e-3, tc1=1e-2,tc2=1.75e-5
                                                                                                      8
res.rgate n9 n20 = 0.7
                                                                                                                        22
res.rldrain n2 n5 = 20
                                                                                                             RVTHRES
res.rlgate n1 n9 = 10
res.rlsource n3 n7 = 4.69
res.rslc1 n5 n51 = 1e-6, tc1=2.8e-3,tc2=14e-6
res.rslc2 n5 n50 = 1e3
res.rsource n8 n7 = 4.5e-3, tc1=0,tc2=0
res.rvtemp n18 n19 = 1, tc1=-2.75e-3,tc2=0.05e-9
res.rvthres n22 n8 = 1, tc1=-2e-3,tc2=-1.75e-5
spe.ebreak n11 n7 n17 n18 = 110
^{.} spe.eds n14 n8 n5 n8 = 1
spe.egs n13 n8 n6 n8 = 1
spe.esg n6 n10 n6 n8 = 1
spe.evtemp n20 n6 n18 n22 = 1
spe.evthres n6 n21 n19 n8 = 1
sw_vcsp.s1a n6 n12 n13 n8 = model=s1amod
sw_vcsp.s1b n13 n12 n13 n8 = model=s1bmod
sw vcsp.s2a n6 n15 n14 n13 = model=s2amod
sw_vcsp.s2b n13 n15 n14 n13 = model=s2bmod
v.vbat n22 n19 = dc=1
equations {
i (n51->n50) +=iscl
(v(n5,n51)/(1e-9+abs(v(n5,n51))))*((abs(v(n5,n51)*1e6/115))**4))
```

Spice Thermal Model

REV APRIL 1998

HUFA75639

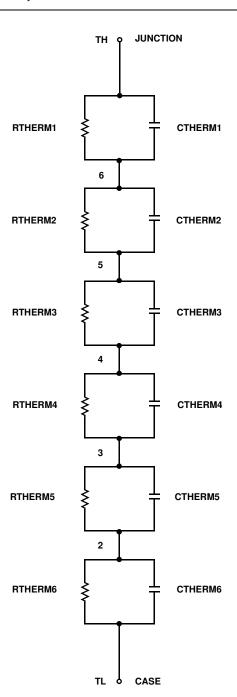
CTHERM1 TH 6 2.8e-3
CTHERM2 6 5 4.6e-3
CTHERM3 5 4 5.5e-3
CTHERM4 4 3 9.2e-3
CTHERM5 3 2 1.7e-2
CTHERM6 2 TL 4.3e-2

RTHERM1 TH 6 5.0e-4
RTHERM2 6 5 1.5e-3
RTHERM3 5 4 2.0e-2
RTHERM4 4 3 9.0e-2
RTHERM5 3 2 1.9e-1
RTHERM6 2 TL 2.9e-1

Saber Thermal Model

Saber thermal model HUFA75639

```
template thermal_model th tl thermal_c th, tl { ctherm.ctherm1 th 6 = 2.8e-3 ctherm.ctherm2 6 5 = 4.6e-3 ctherm.ctherm3 5 4 = 5.5e-3 ctherm.ctherm4 4 3 = 9.2e-3 ctherm.ctherm5 3 2 = 1.7e-2 ctherm.ctherm6 2 tl = 4.3e-2 rtherm.rtherm1 th 6 = 5.0e-4 rtherm.rtherm2 6 5 = 1.5e-3 rtherm.rtherm3 5 4 = 2.0e-2 rtherm.rtherm4 4 3 = 9.0e-2 rtherm.rtherm5 3 2 = 1.9e-1 rtherm.rtherm6 2 tl = 2.9e-1
```



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